

DUAL 150mA HIGH PSRR LOW-DROPOUT CMOS REGULATOR

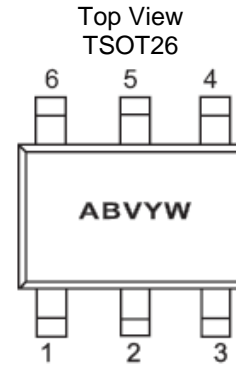
Description

The dual LDO PAM3102 series of positive voltage linear regulators feature high output voltage accuracy, low quiescent current and low dropout voltage, making them ideal for battery powered applications. The line transient response and load transient response are excellent. Their high PSRR make them useful in applications where AC noise on the input power supply must be suppressed. Space-saving TSOT26 package for 2-ch LDOs is attractive for portable and handheld applications. They have both thermal shutdown and a current limit feature to prevent device failure under extreme operating conditions. They are stable with an output capacitance of 2.2µF or greater.

Features

- Output Accuracy: ±2%
- Low Dropout Voltage: 180mV@150mA
- High PSRR: 70dB@100Hz
- Low Noise Output
- Current Limiting
- Short Circuit Protection
- Thermal Shutdown
- Space Saving Package TSOT26
- Pb-Free Package

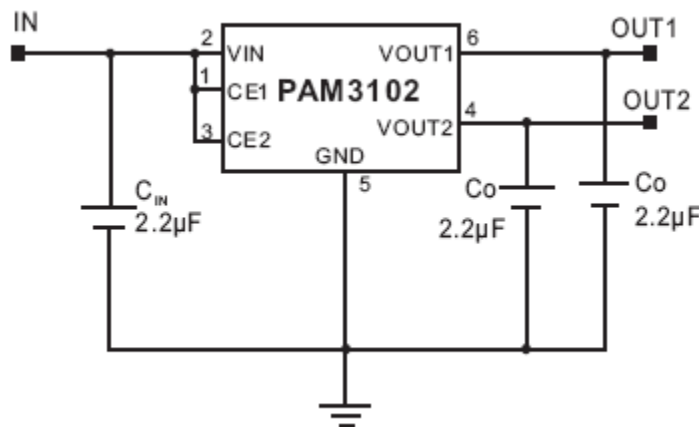
Pin Assignments



Applications

- Cellular Phone
- Portable Electronics, PDA
- Wireless Devices, Wireless LAN
- Computer Peripherals
- Camera Module
- GPS Receiver

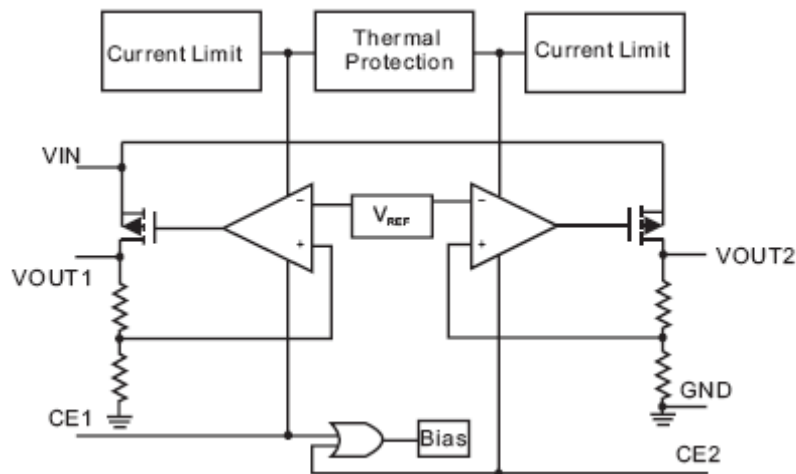
Typical Applications Circuit



Pin Descriptions

Pin Number	Pin Name	Function
1	CE1	Output 1 Enable
2	VIN	Input
3	CE2	Output 2 Enable
4	VOUT2	Output 2
5	GND	Ground
6	VOUT1	Output 1

Functional Block Diagram



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

These are stress ratings only and functional operation is not implied. Exposure to absolute maximum ratings for prolonged time periods may affect device reliability. All voltages are with respect to ground.

Parameter	Rating	Unit
Input Voltage	6.0	V
Output Current	150/150	mA
Output Pin Voltage	GND -0.3 to V _{IN} +0.3V	V
Storage Temperature	-40 to +125	°C
ESD Rating (HBM)	2	kV
Lead Soldering Temperature	300, (5sec)	°C

Recommended Operating Conditions (@T_A = +25°C, unless otherwise specified.)

Parameter	Rating	Unit
Supply Voltage Range	5.5	V
Enable Input Resistance	0 to V _{IN}	V
Junction Temperature	-40 to +125	°C
Operation Temperature	-40 to +85	

Thermal Information

Parameter	Symbol	Package	Max	Unit
Thermal Resistance Junction to Case)	θ _{JC}	TSOT26	130	°C/W
Thermal Resistance (Junction to Ambient)	θ _{JA}	TSOT26	250	
Internal Power Dissipation	P _D	TSOT26	400	mW

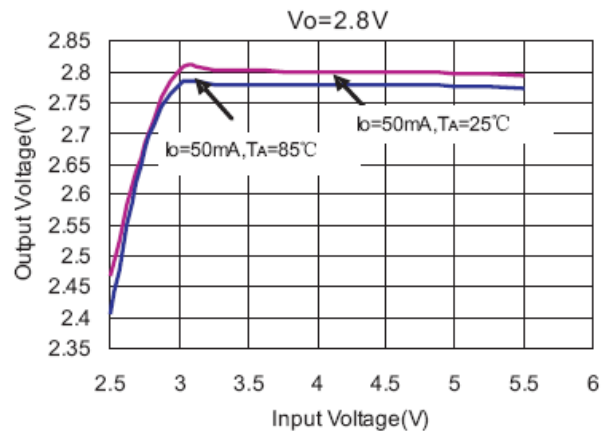
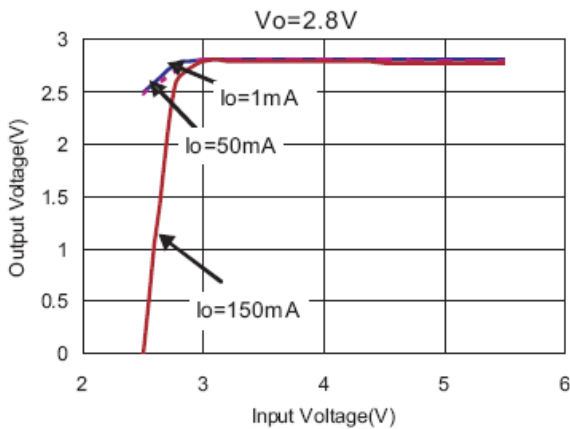
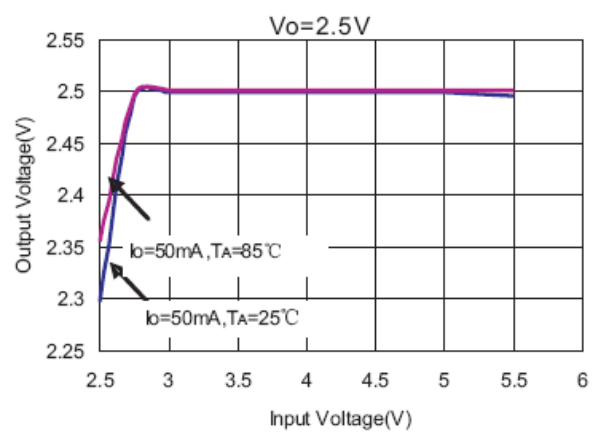
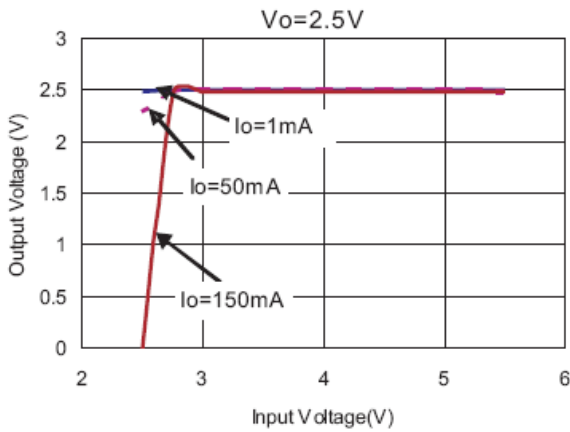
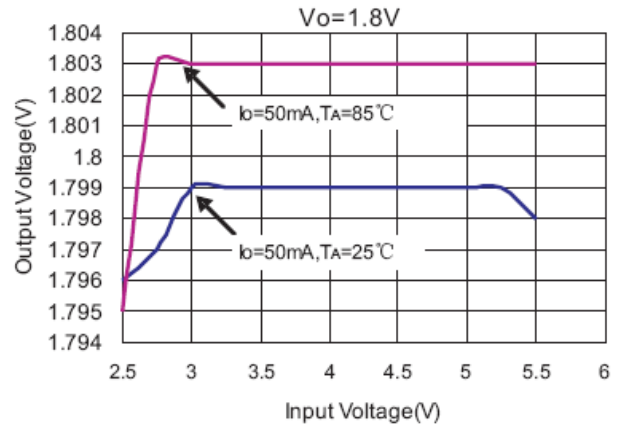
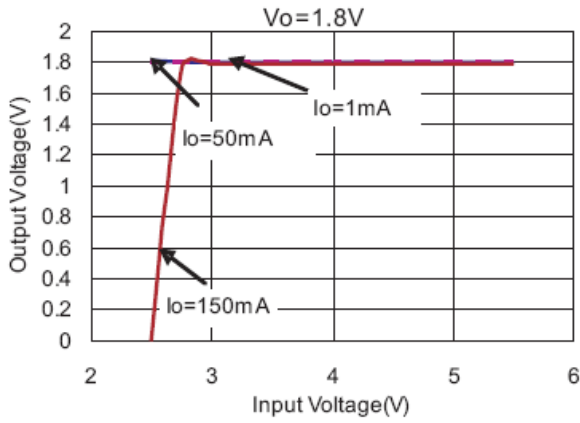
Electrical Characteristics (@T_A = +25°C, V_{CE1} = V_{CE2} = V_{IN} = V_O +1V, C_{IN} = 2.2μF, C_O = 2.2μF, unless otherwise specified.)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units	
Input Voltage	V _{IN}		Note 1		5.5	V	
Output Voltage	V _O	I _O = 1mA	-2.0		+2.0	%	
Dropout Voltage	V _{DROP}	V _O = 1.8V, I _O = 150mA		950		mV	
		V _O = 2.5V, I _O = 150mA		350			
		V _O = 2.8V, I _O = 150mA		180			
Output Current	I _O		150		Note 2	mA	
Current Limit	I _{LIM}	V _O ≥ 1.2V		200		mA	
Quiescent Current	I _Q	I _O = 0mA		175	250	μA	
Ground Pin Current	I _{GND}	I _O = 1mA to 150mA		200	250	μA	
Shutdown Current	I _{SD}	V _{CE1} = V _{CE2} = 0V		0.1	1	μA	
Short Circuit Current	I _{SC}	V _O = 0V		150		mA	
Line Regulation	LNR	I _O = 50mA, V _{IN} = 3V to 4V	V _O = 1.8V	-0.15	0.1	0.15	%V
		I _O = 50mA, V _{IN} = 3.5V to 4.5V	V _O = 2.5V				
		I _O = 50mA, V _{IN} = 3.8V to 4.8V	V _O = 2.8V				
Load Regulation	LDR	V _{IN} = 3.3V, I _O = 1mA to 150mA	-2	1.0	2	%	
Power Supply Ripple Rejection	PSRR	I _O = 50mA, V _O = 1.8V	f = 100Hz	70		dB	
			f = 1kHz	63		dB	
			f = 10kHz	45		dB	
Output Noise	V _N	f = 10Hz to 100kHz		35		μV _{RMS}	
CE Input High Threshold	V _{TH}		1.5			V	
CE Input Low Threshold	V _{TL}				0.3	V	
CE Pull-Up Resistance	R _{CCE}		1.7	5	15	MΩ	
Temperature Coefficient	TC			40		ppm/°C	
Over Temperature Shutdown	OTS	I _O = 1mA		155		°C	
Over Temperature Hysteresis	OTH	I _O = 1mA		40		°C	

Notes: 1. The minimum input voltage (V_{IN(MIN)}) of the PAM3102 is determined by output voltage and dropout voltage. The minimum input voltage is defined as:
 $V_{IN(MIN)} = V_O + V_{DROP}$
 2. Output current is limited by P_D, maximum I_O = P_D / (V_{IN(MAX)} - V_O).

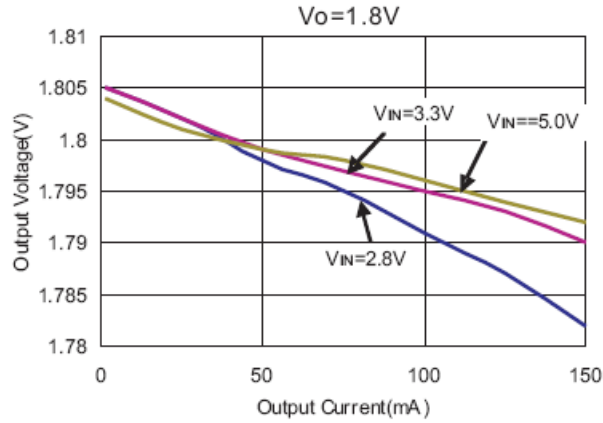
Typical Performance Characteristics (@ $T_A = +25^\circ\text{C}$, $C_{IN} = 2.2\mu\text{F}$, $C_O = 2.2\mu\text{F}$, unless otherwise specified.)

1. Output Voltage vs Input Voltage

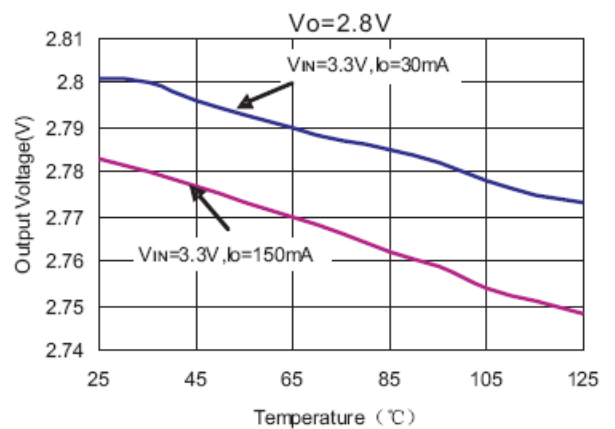
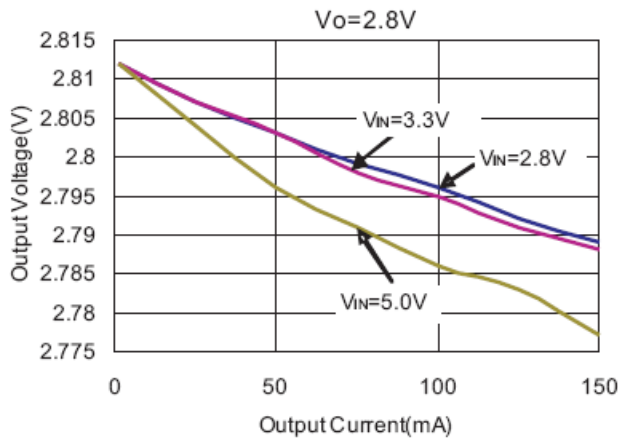
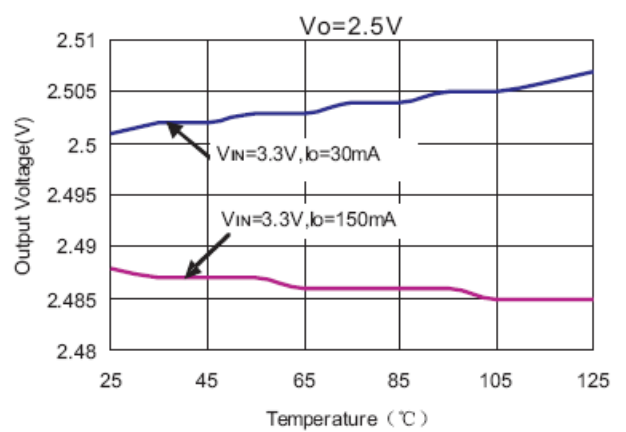
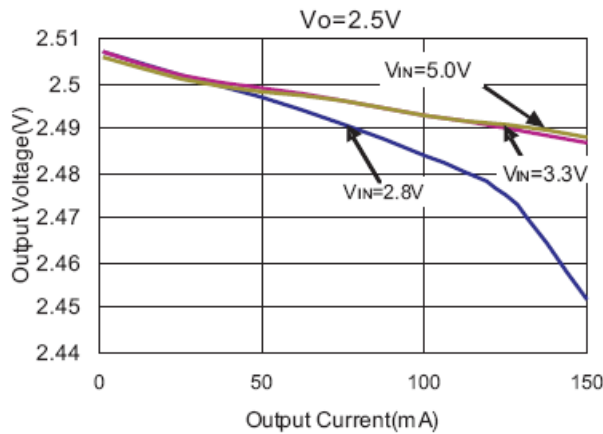
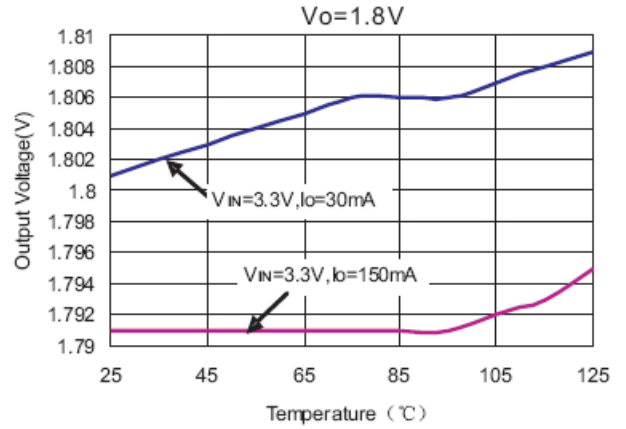


Typical Performance Characteristics (cont.)

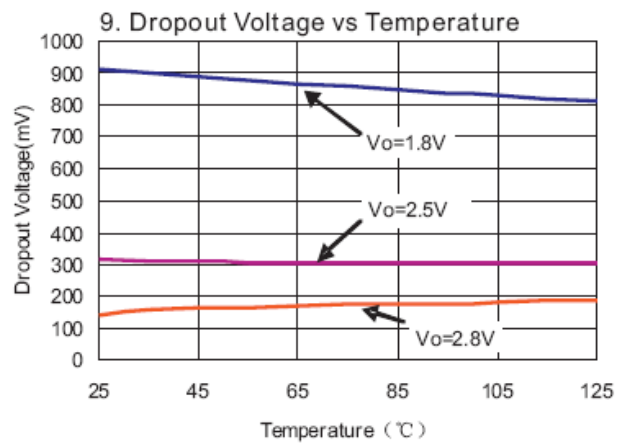
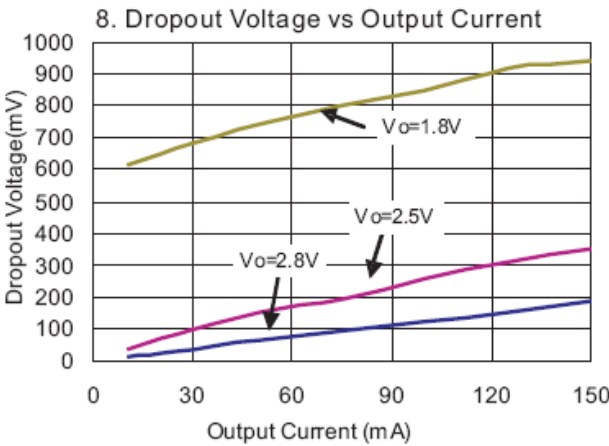
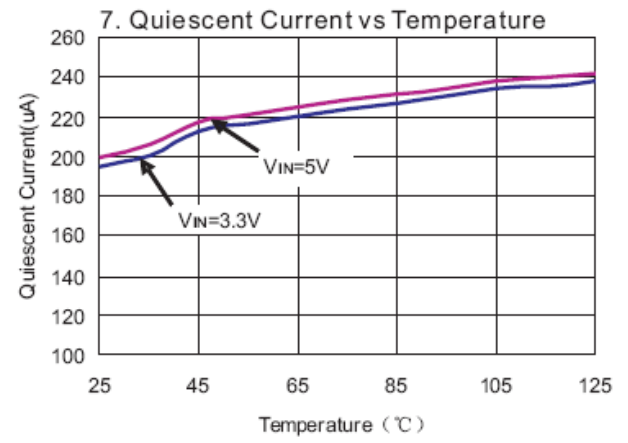
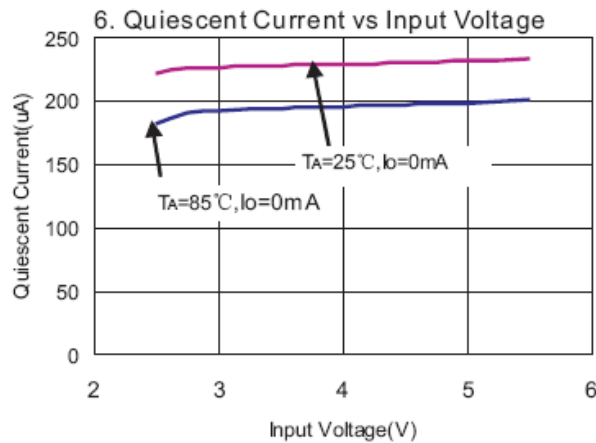
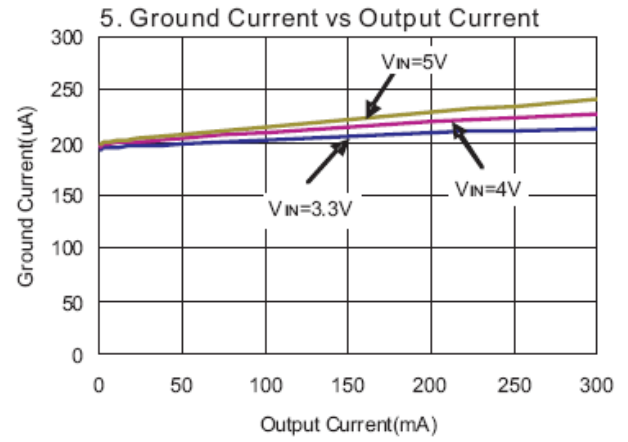
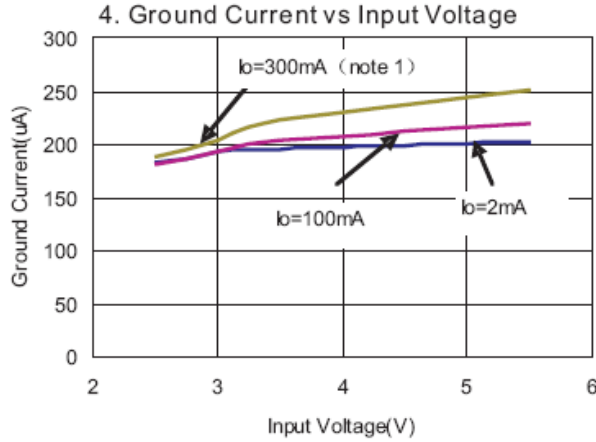
2. Output Voltage vs Output Current



3. Output Voltage vs Temperature



Typical Performance Characteristics (cont.)

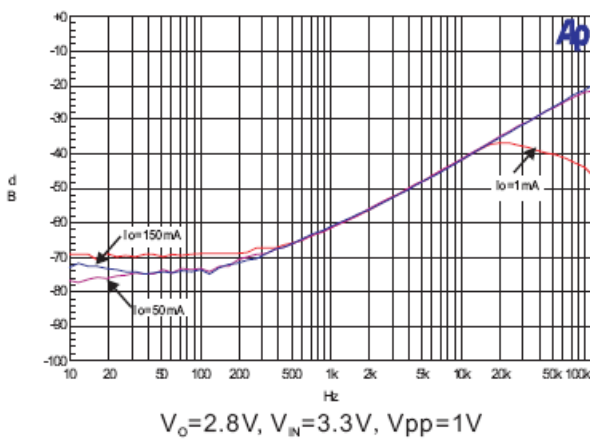
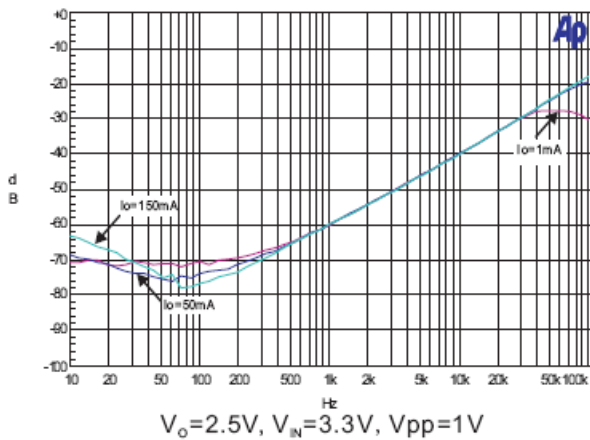
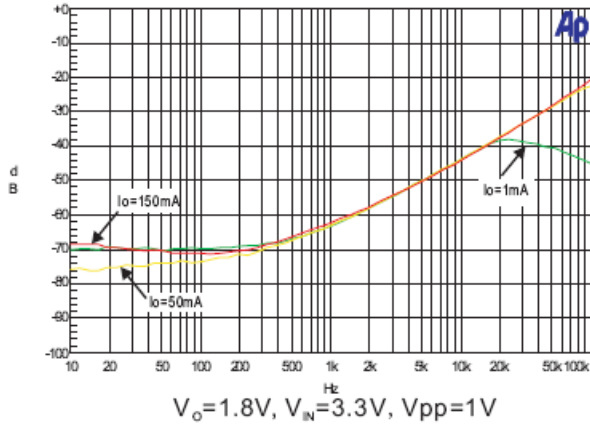


note 1: 2 channels total output current

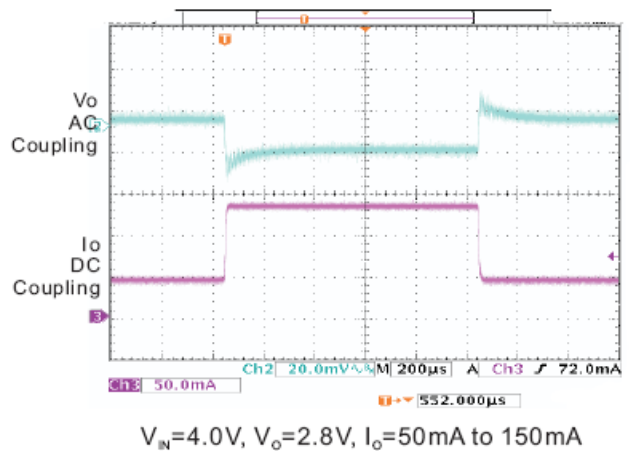
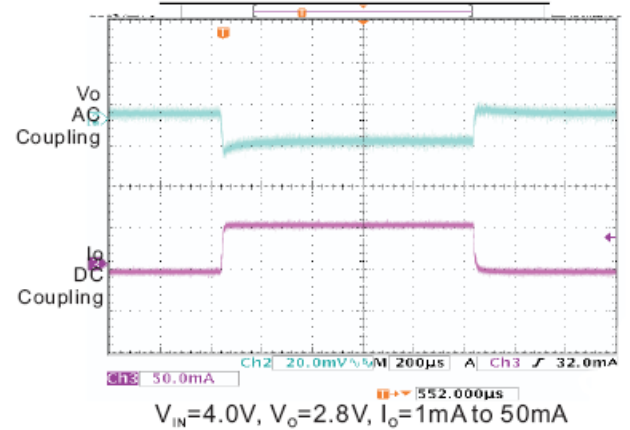
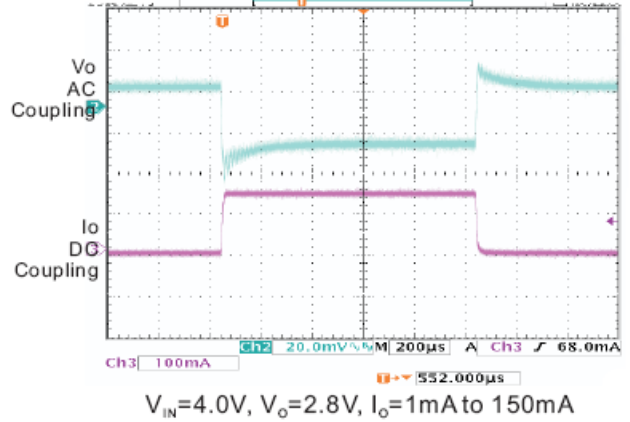
Io=150mA

Typical Performance Characteristics (cont.)

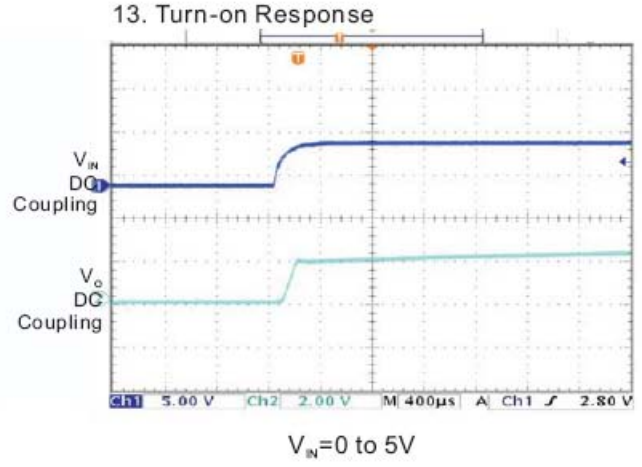
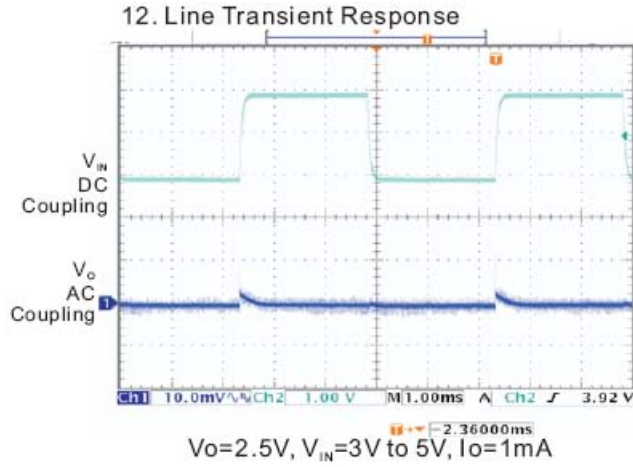
10. Power Supply Ripple Rejection



11. Load Transient Response



Typical Performance Characteristics (cont.)



Application Information

Capacitor Selection and Regulator Stability

Similar to any low dropout regulator, the external capacitors used with the PAM3102 must be carefully selected for regulator stability and performance.

A capacitor C_{IN} of more than $1\mu\text{F}$ can be employed in the input pin, while there is no upper limit for the capacitance of C_{IN} . Please note that the distance between C_{IN} and the input pin of the PAM3102 should not exceed 0.5 inch. Ceramic capacitors are suitable for the PAM3102. Capacitors with larger values and lower ESR (equivalent series resistance) provide better PSRR and line-transient response.

The PAM3102 is designed specifically to work with low ESR ceramic output capacitors in order to save space and improve performance. Using an output ceramic capacitor whose value is $>2.2\mu\text{F}$ with $\text{ESR} > 5\text{m}\Omega$ ensures stability.

Shutdown Input Operation

The PAM3102 is shutdown by pulling the CE input low, and turned on by tying the CE input to V_{IN} or leaving the CE input floating.

Input-Output (Dropout) Voltage

A regulator's minimum input-output voltage differential (or dropout voltage) determines the lowest usable supply voltage. The PAM3102 has a typical 180mV dropout voltage. In battery-powered systems, this will determine the useful end-of-life battery voltage.

Current Limit and Short Circuit Protection

The PAM3102 features a current limit, which monitors and controls the gate voltage of the pass transistor. The output current can be limited to 300mA by regulating the gate voltage. The PAM3102 also has a built-in short circuit current limit.

Thermal Considerations

Thermal protection limits power dissipation in the PAM3102. When the junction temperature exceeds 150°C , the OTP (Over Temperature Protection) starts the thermal shutdown and turns the pass transistor off. The pass transistor resumes operation after the junction temperature drops below 120°C .

For continuous operation, the junction temperature should be maintained below 125°C . The power dissipation is defined as:

$$P_D = (V_{IN} - V_O) * I_O + V_{IN} * I_{GND}$$

The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surrounding airflow and temperature difference between junction and ambient. The maximum power dissipation can be calculated by the following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

Where $T_{J(MAX)}$ is the maximum allowable junction temperature $+125^\circ\text{C}$, T_A is the ambient temperature and θ_{JA} is the thermal resistance from the junction to the ambient.

For example, as is $250^\circ\text{C}/\text{W}$ for the SOT-23 package based on the standard JEDEC 51-3 for a single-layer thermal test board, the maximum power dissipation at $T_A = 25^\circ\text{C}$ can be calculated by following formula:

$$P_{D(MAX)} = (125^\circ\text{C} - 25^\circ\text{C}) / 250 = 0.4\text{W SOT-23}$$

It is also useful to calculate the junction temperature of the PAM3102 under a set of specific conditions. Suppose the input voltage $V_{IN} = 3.3\text{V}$, the output current $I_O = 300\text{mA}$ and the case temperature $T_A = +40^\circ\text{C}$ measured by a thermal couple during operation, the power dissipation is defined as:

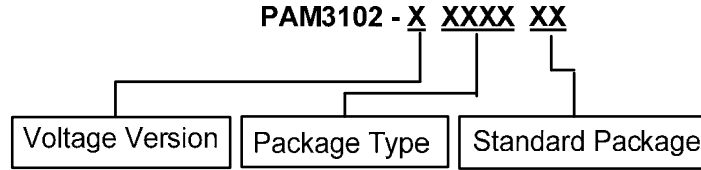
$$P_D = (3.3\text{V} - 2.8\text{V}) * 150\text{mA} + (3.3\text{V} - 1.8\text{V}) * 150\text{mA} + 3.3\text{V} * 200\mu\text{A} \cong 300\text{mW}$$

And the junction temperature T_J can be calculated as follows:

$$\begin{aligned} T_J &= T_A + P_D * \theta_{JA} \\ T_J &= 40^\circ\text{C} + 0.3\text{W} * 250^\circ\text{C}/\text{W} \\ &= 40^\circ\text{C} + 75^\circ\text{C} \\ &= 115^\circ\text{C} < T_{J(MAX)} = +125^\circ\text{C} \end{aligned}$$

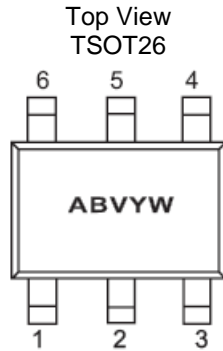
For this application, T_J is lower than the absolute maximum operating junction temperature, $+125^\circ\text{C}$, so it is safe to use the PAM3102 in this configuration.

Ordering Information



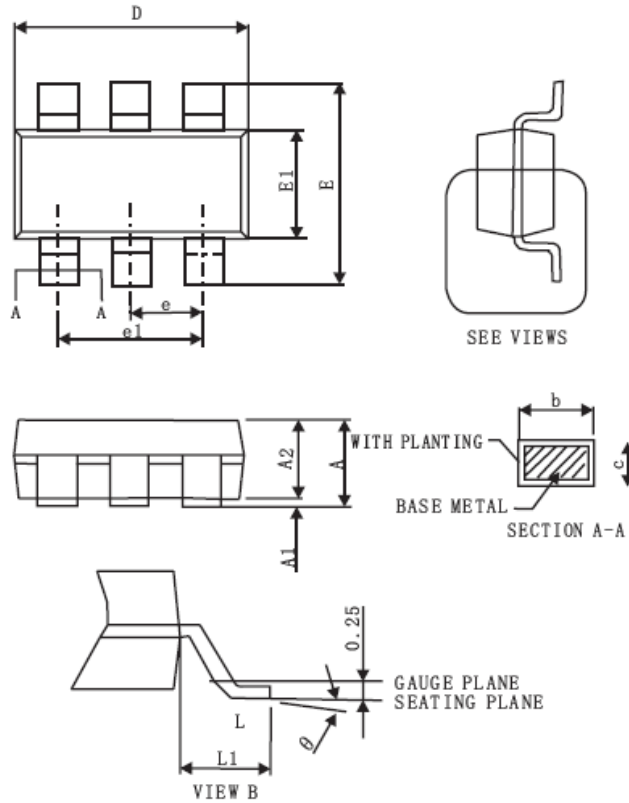
Part Number	Output Voltage	Part Marking	Package Type	Standard Package
PAM3102-AST26R1	VOUT1 1.8V VOUT2 2.8V	ABAYW	TSOT26	3000Units/Tape&Reel
PAM3102-BST26R1	VOUT1 1.8V VOUT2 2.5V	ABBYW	TSOT26	3000Units/Tape&Reel

Marking Information



AB: Product Code of PAM3102
V: Voltage Code
Y: Year
W: Week

Package Outline Dimensions (All dimensions in mm.)



Symbol	A	A1	A2	b	c	D	E
Spec	1.20±0.25	0.10±0.05	1.10±0.2	0.40±0.1	0.15±0.07	2.90±0.1	2.80±0.2
Symbol	E1	e	e1	L	L1	θ	
Spec	1.60±0.1	0.95BSC	1.90BSC	0.55±0.25	0.60REF	4°±4°	

Unit: Millimeter

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